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Page 1 of 3

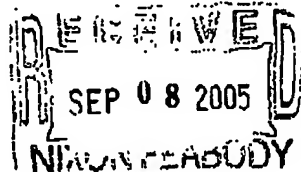
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APPL. NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
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22204
NIXON PEABODY, LLP
401 9TH STREET, NW
SUITE 900
WASHINGTON, DC 20004-2128

CONFIRMATION NO. 4216

FILING RECEIPT



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Date Mailed: 09/02/2005

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Applicant(s)Masuo Kondo, Osaka, JAPAN;
Fumiaki Kikui, Osaka, JAPAN;**Assignment For Published Patent Application**

Neomax Materials Co., Ltd., Suita-shi, Osaka, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 22204.**Domestic Priority data as claimed by applicant**

This application is a 371 of PCT/JP03/12183 09/24/2003

Foreign ApplicationsJAPAN 2003-283301 09/27/2002
JAPAN 2002-291187 10/03/2002**Projected Publication Date:** 12/08/2005**Non-Publication Request:** No**Early Publication Request:** No9/8/05 Docketed
By SOW / hch
Nixon Peabody, LLP

Title

SOLDER BALL METHOD OF MAKING THE SAME, AND METHOD OF MAKING
~~Solder-coated ball and method for manufacture thereof, and method for forming semiconductor interconnecting structure~~
SEMICONDUCTOR INTERCONNECT STRUCTURE

Preliminary Class

438

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